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RB

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

EXAMINER

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10084869	03/01/2002*	450 528	2560	1712	AYLWARD, D

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108
TSC6#7

**CONTINUING DATA VERIFIED: None *Daw*

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** FOREIGN APPLICATIONS VERIFIED: None *Daw*

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed		<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 119 conditions met		<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	1988.EEM
Verified and Acknowledged Examiner's initials <i>Daw</i>			
TITLE : Underfill encapsulant for wafer packaging and method for its application			
U.S. DEPT. OF COMM /PAT & TM-PTO-425L(Rev. 12-94)			

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
9-16-03		D. Aylward, 9/9/03 Assistant Examiner	
ISSUE FEE		Robert Dawson Supervisory Patent Examiner Technology Center 1700	
Amount Due	Date Paid	Primary Examiner <i>Robert Dawson</i>	
\$1600		PREPARED FOR ISSUE Application Examiner <i>Robert Dawson 9/11/03</i>	
<input type="checkbox"/> TERMINAL DISCLAIMER		WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368. Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.	

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